

## **Applicant Information**

Applicant Authority Type:: Inventor  
Applicant One Given Name:: Hung-Shun  
Family Name:: Chao  
Postal Address Line One:: No. 22-4, Sec. 2, Zhiyu Rd.  
Postal Address Line Two:: Shilin District  
City:: Taipei City  
Country:: Taiwan, R.O.C.  
Postal or Zip Code:: 111  
Country of Residence:: Taiwan, R.O.C.  
Citizenship Country:: Taiwan, R.O.C.

Applicant Authority Type:: Inventor  
Applicant Two Given Name:: Chun-Ming  
Family Name:: Hu  
Postal Address Line One:: 4<sup>th</sup> FL, #32, Lane 218  
Postal Address Line Two:: Nan-Ya Street  
City:: Hsin-Chu City  
Country:: Taiwan, R.O.C.  
Country of Residence:: Taiwan, R.O.C.  
Citizenship Country:: Taiwan, R.O.C.

## **Correspondence Information**

Correspondence Customer Number:: 000027683

### **Application Information**

Title Line One:: A SYSTEM AND METHOD FOR PREDICTING  
Title Line Two:: A PARAMETER FOR A LITHOGRAPHY OVERLAY  
Title Line Three:: FIRST LOT  
Total Drawing Sheets:: 4  
Formal Drawings?:: No  
Application Type:: Utility  
Docket Number:: 24061.121 (TSMC2003-0710)

### **Representative Information**

Registration Number:: 50,925

### **Assignee Information**

Assignee Name:: Taiwan Semiconductor Manufacturing Co., Ltd.  
Street of mailing address:: No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park  
City:: Hsin-Chu  
State or Province:: Taiwan, R.O.C.  
Country of mailing address:: Taiwan, R.O.C.  
Postal or Zip Code:: 300-77

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